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Coiltronics HCM1707 Series

High current power inductors



Product description

- · High current carrying capacity
- · Magnetically shielded, low EMI
- · Frequency range up to 1MHz
- Inductance range from 1.5μH to 68.0μH
- · Current range from 5.2 to 40.0 amps
- 17.5x17.2mm footprint surface mount package in a 7.0mm height
- · Powder iron core material
- · Halogen free, lead free, RoHS compliant

Applications

- · Voltage Regulator Module (VRM)
- · Multi-phase regulators
- · Point-of-load modules
- · Desktop and server VRMs and EVRDs
- · Data networking and storage systems
- · Base station equipment
- · Battery power systems

Environmental data

- Storage temperature range (Component): -55°C to +125°C
- Operating temperature range: -55°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant







The Coiltronics brand of magnetics (formerly of the Bussmann Division of Cooper Industries) is now part of Eaton's Electrical Group, Electronics Division.





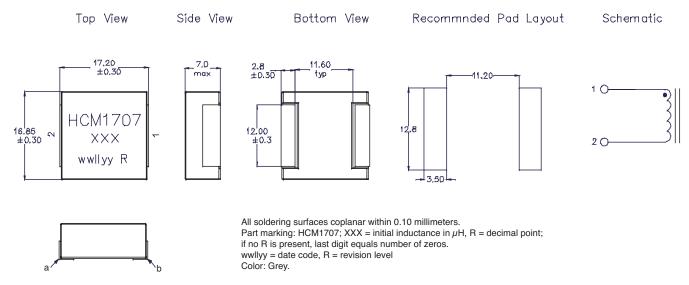
Product specifications

Part Number ⁶	OCL¹ ±20% (µH)	FLL min.² (µH)	I _{rms} ³ (amps)	l _{sat} ⁴ (amps)	DCR (mΩ) @ 20°C (typical)	DCR (mΩ) @ 20°C (maximum)	K-factor⁵
HCM1707-1R5-R	1.5	0.96	40	40	1.85	2.15	124
HCM1707-2R2-R	2.2	1.41	37	34	2.15	2.50	103
HCM1707-4R7-R	4.7	3.01	27	24	4.12	4.72	76
HCM1707-6R8-R	6.8	4.35	20	22	6.55	7.55	60
HCM1707-8R2-R	8.2	5.25	16	20	8.10	8.70	55
HCM1707-100-R	10	6.40	14	18	9.30	10	47
HCM1707-150-R	15	9.60	12	13	14.5	15.5	43
HCM1707-220-R	22	14.1	9.5	11	21	23	37
HCM1707-330-R	33	21.1	9.0	10	35	37	28
HCM1707-470-R	47	30.1	6.8	7.5	41	47	25
HCM1707-680-R	68	43.5	5.2	6.5	74	85	20

- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.25V $_{\rm ms^\prime}$ 0.0Adc, +25°C.
- 2. Full Load Inductance (FLL): Test parameters: 100kHz, 0.25V $_{\rm rms'}$ I $_{\rm sat'}$ +25°C.
- 3.1_{mm}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +125°C under worst case operating conditions verified in the end application.
- 4. I Peak current for approximately 20% rolloff at +25°C.

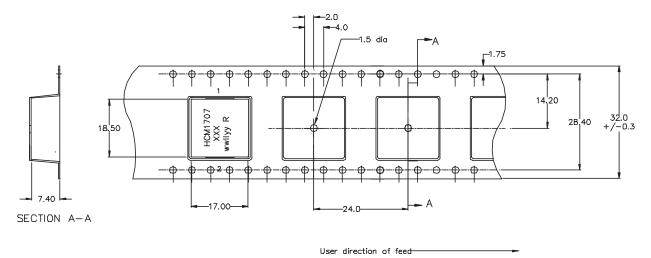
- 5. K-factor: Used to determine B_{pp} for core loss (see graph). $B_{pp} = K * L * \Delta I$. B_{pp} :(Gauss), K: (K-factor from table), L: (Inductance in μ H), ΔI (Peak to peak ripple current in amps).
- 6. Part Number Definition: HCM1707-yyy-R
- HCM1707 = Product code and size
- yyy= Inductance value in uH, R = decimal point, if no R is present then third character = number of zeros.
- "-R" suffix = RoHS compliant

Dimensions - mm



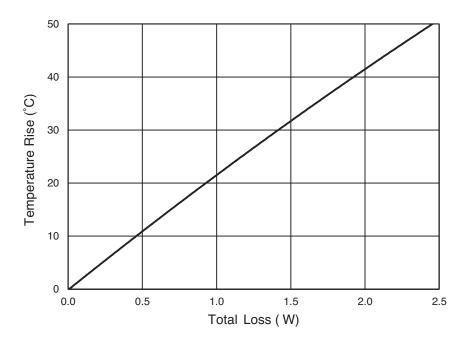
DCR measured between point "a" and point "b"

Packaging information - mm



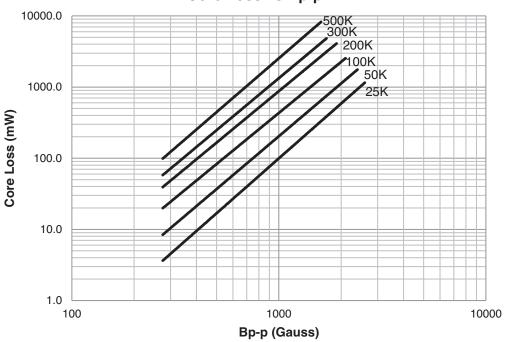
Supplied in tape and reel packaging, 350 parts per 13" diameter reel.

Temperature rise vs. total loss

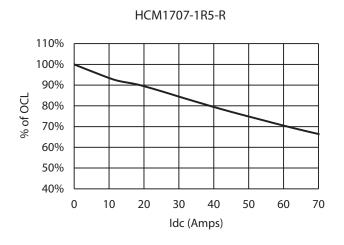


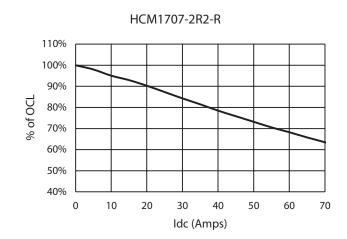
Core loss



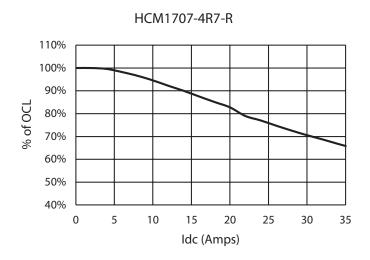


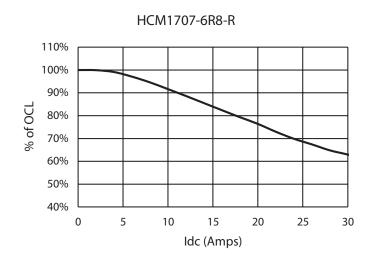
Inductance characteristics

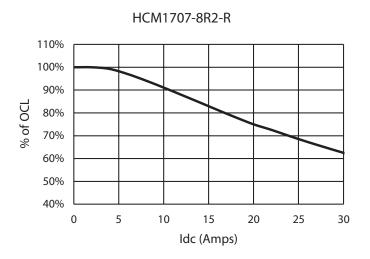


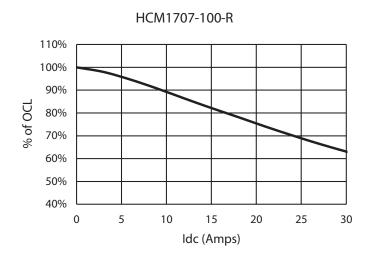


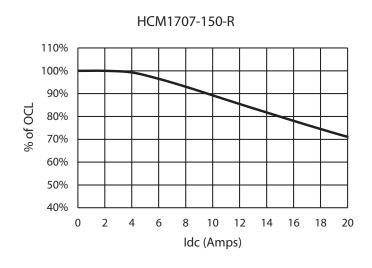
Inductance characteristics

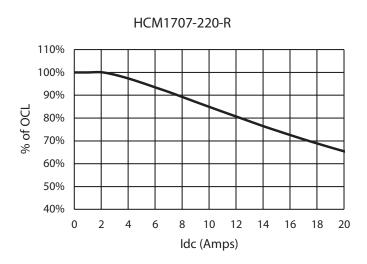




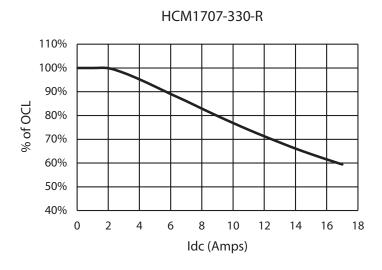


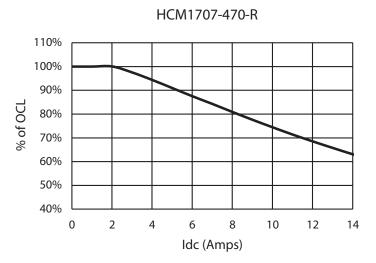


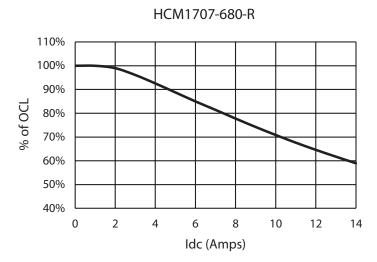




Inductance characteristics







Solder reflow profile

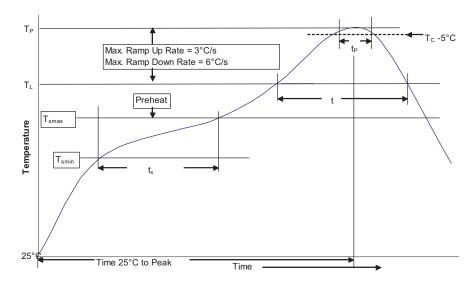


Table 1 - Standard SnPb Solder (T_c)

	ckage hickness	Volume mm³ <350	Volume mm³ ≥350
_<	2.5mm	235°C	220°C
_	2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package Thickness	Volume mm³ <350	Volume mm ³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C	
	Temperature max. (T _{smax})	150°C	200°C	
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{Smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (Tp)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

^{*} Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (t_0) is defined as a supplier minimum and a user maximum.